

Q2B94040C00F000

MSA and TAA 100GBase-BX ER1 QSFP28 Transceiver Single Lambda (SMF, 1309.14nmTx/1304.58nmRx, 40km, LC, DOM)

Product Description

This MSA Compliant QSFP28 transceiver provides 100GBase-BX ER1 throughput up to 40km over single-mode fiber (SMF) using a wavelength of 1309.14nmTx/1304.58nmRx via an LC connector. It is built to MSA standards and is uniquely serialized and data-traffic and application tested to ensure that they will integrate into your network seamlessly. Digital optical monitoring (DOM) support is also present to allow access to real-time operating parameters. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

Skylane's transceivers are RoHS compliant and lead-free.

Features:

- SFF-8636 Rev. 2.10a Compliant
- 100G Lambda MSA 100G-ER1 Specification Compliant
- QSFP28 MSA Compliant
- Bidi LC Receptacles
- Commercial Temperature 0 to 70 Celsius
- Supports 100Gbps with 4x25G Electrical Interface
- Power Dissipation:
- Single 3.3V Power Supply
- RoHS Compliant and Lead Free
- SMF with Inbuild KP4 FEC



Applications:

100GBase Ethernet

ESD

Datacenter

For your product safety, please read the following information carefully before any manipulation of the transceiver:



LASER SAFETY

This is a Class1 Laser Product according to IEC 60825-1:2007. This product complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated (June 24, 2007).

This transceiver is specified as ESD threshold 1kV for SFI pins and 2kV for all others electrical input pins, tested per MIL-STD-883G, Method

The optical ports of the module need to be terminated with an optical connector or with a dust plug in order to avoid contamination.

3015.4 /JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Maximum Supply Voltage	Vcc	-0.5		3.6	V	
Storage Temperature	Tstg	-40		85	°C	
Maximum Operating Case Temperature	Тс	-5		75	°C	
Recommended Operating Case Temperature	Тс	0		70	°C	1
Operating Relative Humidity	RH	5		85	%	

Notes:

- 1. The position of case temperature measurement is shown in the Mechanical Specifications section.
- 2. Exceeding the Absolute Maximum Ratings table may cause permanent damage to the device. This is just an emphasized rating and does not involve the functional operation of the device that exceeds the specifications of this technical specification under these or other conditions. Long-term operation under Absolute Maximum Ratings will affect the reliability of the device.

Electrical Characteristics

Parameter	Symbol/ Test Point	Min.	Тур.	Max.	Unit	Notes
Power Supply Voltage	Vcc	3.135	3.3	3.465	V	
Power Supply Noise				66	mVp-p	1
Power Consumption				4.5	W	
Total Power Supply Current				1298	mA	
Internal AC Coupling Capacitors			0.1		μF	
Electrical Signal Rate			25.78125		Gbps	
High-Speed Electrical Input Characteristics (Tran	nsmitter)	1	1	1	1	1
Differential Pk-Pk Input Voltage Tolerance	TP1a	900			mVp-p	
Differential Input Impedance	TP1	90	100	110	Ω	
Output Rise/Fall Time	TP1a	10			ps	2
Eye Width	TP1a	0.46			UI	3
Eye Heigh Differential	TP1a	95			mV	3
DC Common-Mode Voltage (Vcm)	TP1	-350		2850	mV	4
High-Speed Electrical Output Characteristics (Re	eceiver)				1	'
Receiver Differential Data Output Load			100		Ω	
Differential Pk-Pk Output Voltage	TP4			900	mVp-p	
Differential Output Impedance	TP4	90	100	110	Ω	
Output Rise/Fall Time	TP4	12			ps	2
Eye Width	TP4	0.57			UI	3

Eye Height Differential	TP4	228		mV	3
DC Common-Mode Voltage (Vcm)	TP4	-350	2850	mV	4

- Power supply noise is defined as the peak-to-peak noise amplitude over the frequency range at the host supply side of the recommended power supply filter with the module and recommended filter in place. Voltage levels including peak-to-peak noise are limited to the recommended operating range of the associated power supply.
- 2. 20-80%.
- 3. 1E⁻¹⁵.
- 4. Vcm is generated by the host. Specification includes effects of ground offset voltage.

Optical Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes	
Optical Signal Rat			53.125		Gbaud		
Fiber Length (9µm	n SMF)				40	km	1
Transmitter @TP2	2 Test Point						
Signaling Speed				53.125		Gbaud	
Modulation Form	at			PAM4			
Center Wavelengt	th	λC	1308.61	1309.14	1309.66	nm	
Side-Mode Suppre	ession Ratio	SMSR	30			dB	
Extinction Ratio		ER	5			dB	
Outer Optical	For TDECQ<1.4dB	ТхОМА	4.7		7.9	dBm	
Modulation Amplitude	For 1.4dB≤TDECQ≤3.9dB	TxOMA	3.3+TDECQ			dBm	
Transmit Average		TxAVG	1.7		7.1	dBm	2
Transmitter and D	Dispersion Eye Closure	TDECQ			3.9	dB	
Launch Power of	Off Transmitter Per Lane				-15	dBm	
Relative Intensity	Noise	RIN			-136	dB/Hz	
Optical Return Lo	ss Tolerance				15	dB	3
Receiver @TP3 Te	est Point						
Signaling Speed				53.125		Gbaud	
Center Wavelengt	th	λC	1304.06	1304.58	1305.1	nm	
Damage Threshol	d	Rxdmg	-2.4			dBm	
Receive Power (O	MAouter)	RxOMA			-2.6	dBm	
Average Receive	Power	RxAVG	-16		-3.4	dBm	
Receiver	For TECQ<1.4dB	SenOMA			-13.8	dBm	4
Sensitivity (OMAouter)	For 1.4dB≤TECQ≤3.9dB	SenOMA			TECQ-15.2	dBm	4
Stressed Receiver Sensitivity		SRS			-11.3	dBm	
Receiver Reflectance					-26	dB	
LOS Assert		LOSA	-26			dBm	
LOS De-Assert		LOSD			-17	dBm	

- 1. 9μm SMF. The maximum link distance is based on an allocation of 1dB of attenuation and 3dB total connection and splice loss. The loss of a single connection shall not exceed 0.5dB.
- 2. Average launch power (minimum) is informative and not the principal indicator of signal strength. A transmitter with launch power below this value cannot be compliant; however, a value above this does not ensure compliance.
- 3. Transmitter reflectance is defined looking into the transmitter.
- 4. Sensitivity is specified at 2.4×10^{-4} BER with PRBS31Q.

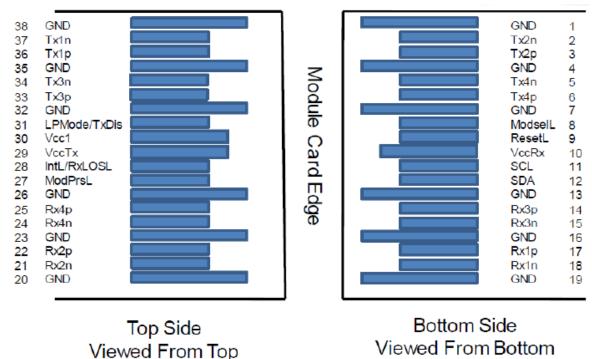
Pin Descriptions

Pin	Logic	Symbol	Name/Description	Plug Sequence	Notes
1		GND	Module Ground.	1	1
2	CML-I	Tx2-	Transmitter Inverted Data Input.	3	
3	CML-I	Tx2+	Transmitter Non-Inverted Data Input.	3	
4		GND	Module Ground.	1	1
5	CML-I	Tx4-	Transmitter Inverted Data Input.	3	
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	3	
7		GND	Module Ground.	1	1
8	LVTTL-I	ModSelL	Module Select.	3	
9	LVTTL-I	ResetL	Module Reset.	3	
10		VccRx	+3.3V Receiver Power Supply.	2	2
11	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock.	3	
12	LVCMOS-I/O	SDA	2-Wire Serial Interface Data.	3	
13		GND	Module Ground.	1	1
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	3	
15	CML-O	Rx3-	Receiver Inverted Data Output.	3	
16		GND	Module Ground.	1	1
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	3	
18	CML-O	Rx1-	Receiver Inverted Data Output.	3	
19		GND	Module Ground.	1	1
20		GND	Module Ground.	1	1
21	CML-O	Rx2-	Receiver Inverted Data Output.	3	
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	3	
23		GND	Module Ground.	1	1
24	CML-O	Rx4-	Receiver Inverted Data Output.	3	
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	3	
26		GND	Module Ground.	1	1
27	LVTTL-O	ModPrsL	Module Present.	3	
28	LVTTL-O	IntL/RxLOSL	Interrupt. Optionally configurable as RxLOSL via the management interface (SFF-8636).	3	
29		VccTx	+3.3V Transmitter Power Supply.	2	2
30		Vcc1	+3.3V Power Supply.	2	2
31	LVTTL-I	LPMode/TxDis	Low-Power Mode. Optionally configurable as TxDis via the management interface (SFF-8636).	3	
32		GND	Module Ground.	1	1
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	3	
34	CML-I	Tx3-	Transmitter Inverted Data Input.	3	

35		GND	Module Ground.	1	1
36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	3	
37	CML-I	Tx1-	Transmitter Inverted Data Input.	3	
38		GND	Module Ground.	1	1

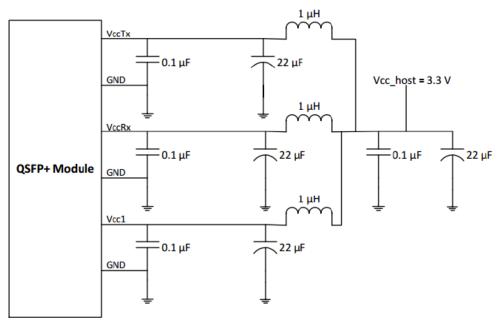
Notes:

- 1. GND is the symbol for signal and supply (power) common for the module. All are common within the module, and all module voltages are referenced to this potential unless otherwise noted. Connect them directly to the host board signal-common ground plane.
- VccRx, Vcc1, and VccTx are the receiving and transmission power suppliers and are applied concurrently. VccRx, Vcc1, and VccTx are internally connected within the module in any combination. Vcc contacts in SFF-8662 and SFF-8672 each have a steady state current rating of 1A.



QSFP28 Transceiver Electrical Pad Layout

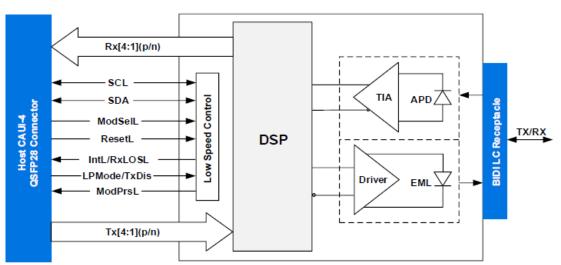
Host Board Power Supply Filter



Notes:

1. During power transient events, the host should ensure that any neighboring modules sharing the same supply stay within their specified supply voltage limits. The host should also ensure that the intrinsic noise of the power rail is filtered in order to guarantee the correct operation of the optical modules.

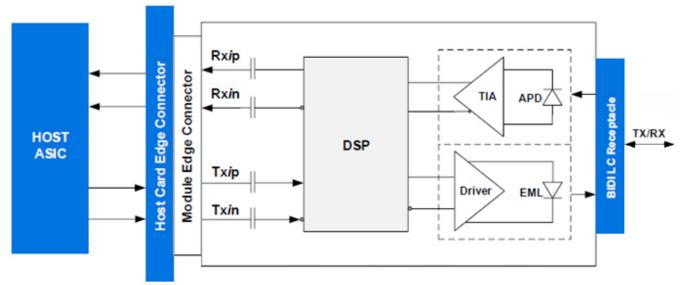
Transceiver Block Diagram



Notes:

1. The transmitter path of the transceiver contains a 4x25Gbps CAUI-4 electrical input, integrated electrical multiplexer, EML driver, EML laser, and diagnostic monitor. The integrated electrical multiplexer converts 4 channels of 25Gbps (NRZ) electrical input data to 1 channel of 100Gbps (PAM4) optical signal.

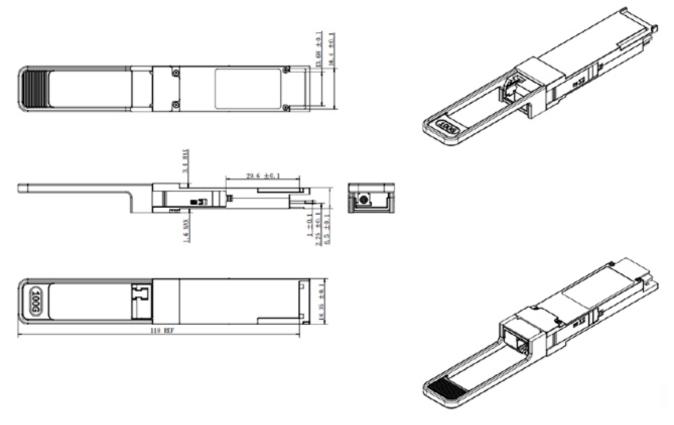
 The receiver path of the transceiver contains an APD, trans-impedance amplifier (TIA), integrated demultiplexer, and 4x25Gbps CAUI-4 compliant electrical output block. The integrated de-multiplexer converts 1 channel of 100Gbps (PAM4) optical signal to 4 channels of 25Gbps (NRZ) electrical output data.



Application Reference Diagram

- 1. Only one channel "i" (i = 1, 2, 3, 4) shown for simplicity.
- The interface between the QSFP28 module and the ASIC/SerDes is shown above. The high-speed signal lines are internally AC coupled, and the electrical inputs are internally terminated to 100Ω differential. All transmitter and receiver electrical channels are compliant to CAUI-4 specification per IEEE 802.3cd.
- The module has the following low-speed signals for control and status: ModSelL, ResetL, LPMode/TxDis, ModPrsL, and IntL/RxLOSL. In addition, there is an industry-standard 2-wire serial interface scaled for 3.3V LVTTL. The definition of control signal interface and the registers of the serial interface memory are further defined in this document.
- 4. Exposure to current urges and overvoltage events can cause immediate damage to the transceiver module. Observe the precautions for normal operation of electrostatic discharge-sensitive equipment. Attention should also be taken to restrict exposure to the conditions defined in the Absolute Maximum Ratings. Optical connectors will be exposed if the port plug is not inserted, so always pay attention to protection. Each module is equipped with a port guard plug to protect the optical ports. The protective plug shall always be in place whenever the optical fiber is not inserted. Before inserting the optical fiber, it is recommended to clean the end of the optical fiber connector to avoid contamination of the module optical port due to a dirty connector. If contamination occurs, use standard LC port cleaning methods.

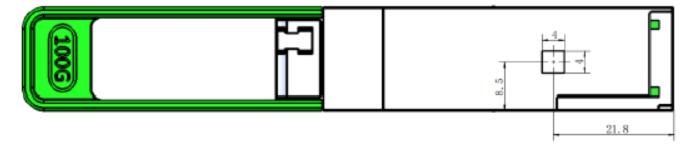
Mechanical Specifications



Notes:

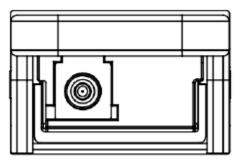
- 1. All dimensions are in mm.
- 2. Unmarked tolerance complies with GB/T1804-M.

Case Temperature Measurement Point



- 1. All dimensions are in mm.
- 2. The above picture shows the location of the hottest spot for measuring module case temperature. In addition, the Digital Diagnostic Monitoring (DDM) temperature is also calibrated to this spot.

Module Optical Interface (Looking into the Optical Port)



About Skylane Optics

Skylane is a leading provider of transceivers for optical communication.

We offer an extensive portfolio for the enterprise, access, datacenter and metropolitan fiber optical market as well as for smart home applications and home networks.

We cover the European, South American and North American market with a strong partner network and have offices in Belgium, Brazil, Sweden and USA.

Our offerings are characterized by high quality and performance. In combination with our strong technical support, we enable our customers to build cost optimized network solutions.

We offer an extensive range of high-quality products including transceivers (Optical and copper), Active Optical Cable (AOC), Direct Attach Cable (DAC), Mux/Demux, Coding Box (SKYGATE).









